

## N-Channel 60-V (D-S) MOSFET

### PRODUCT SUMMARY

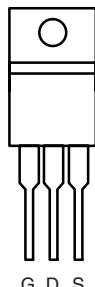
$V_{(BR)DSS}$ (V)	$r_{DS(on)}$ ( $\Omega$ )	$I_D$ (A)	$Q_g$ (Typ)
60	0.006 at $V_{GS} = 10$ V	90 <sup>d</sup>	78.5

### FEATURES

- TrenchFET® Power MOSFET
- 175 °C Junction Temperature
- 100 %  $R_g$  and UIS Tested

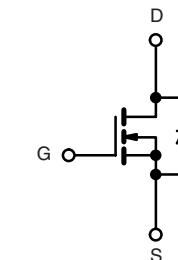


TO-220AB



Top View

Ordering Information: SUP90N06-6m0P-E3 (Lead (Pb)-free)



N-Channel MOSFET

### ABSOLUTE MAXIMUM RATINGS $T_C = 25$ °C, unless otherwise noted

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	$V_{DS}$	60	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	
Continuous Drain Current ( $T_J = 175$ °C)	$I_D$	90 <sup>d</sup>	A
		90 <sup>d</sup>	
Pulsed Drain Current	$I_{DM}$	240	
Avalanche Current	$I_{AS}$	50	
Single Avalanche Energy <sup>a</sup>	$E_{AS}$	125	mJ
Maximum Power Dissipation <sup>a</sup>	$P_D$	272 <sup>b</sup>	W
		3.75	
Operating Junction and Storage Temperature Range	$T_J, T_{stg}$	- 55 to 175	°C

### THERMAL RESISTANCE RATINGS

Parameter	Symbol	Limit	Unit
Junction-to-Ambient (PCB Mount) <sup>c</sup>	$R_{thJA}$	40	°C/W
Junction-to-Case (Drain)	$R_{thJC}$	0.55	

Notes:

- a. Duty cycle  $\leq 1$  %.
- b. See SOA curve for voltage derating.
- c. When Mounted on 1" square PCB (FR-4 material).
- d. Package limited.

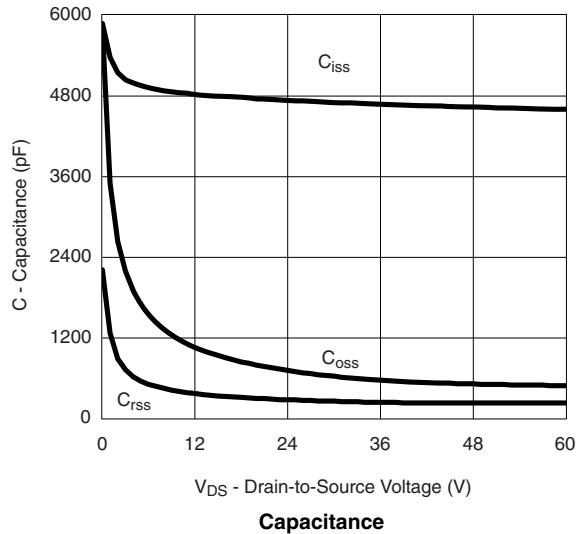
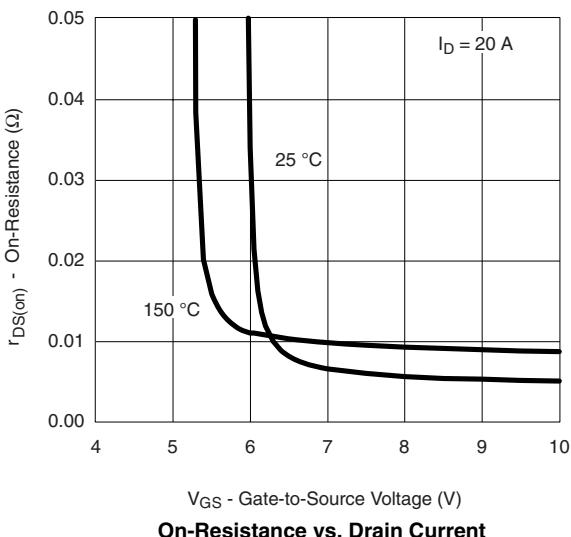
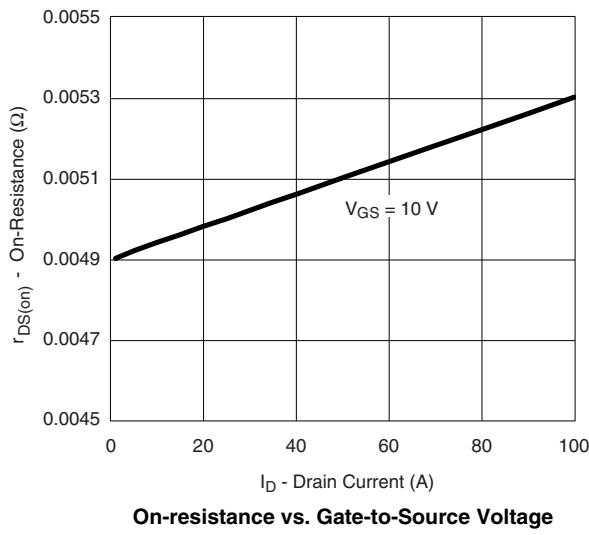
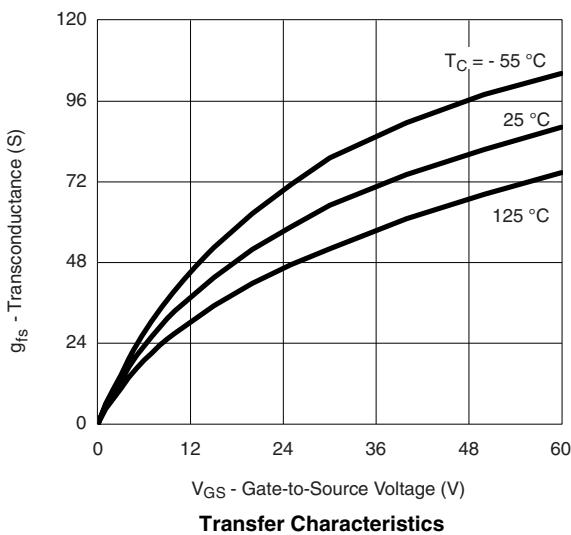
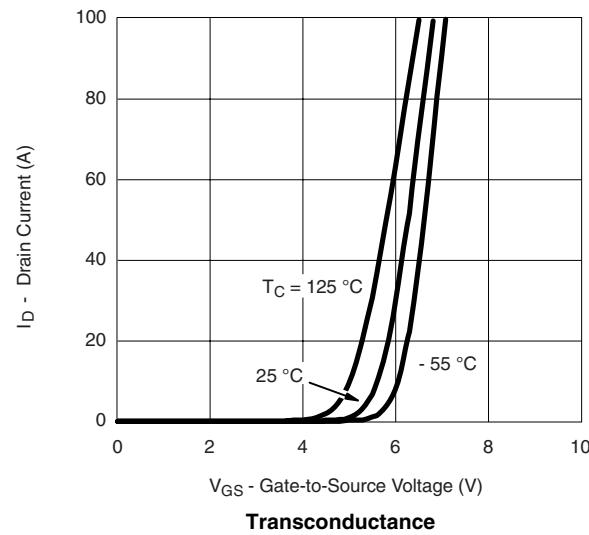
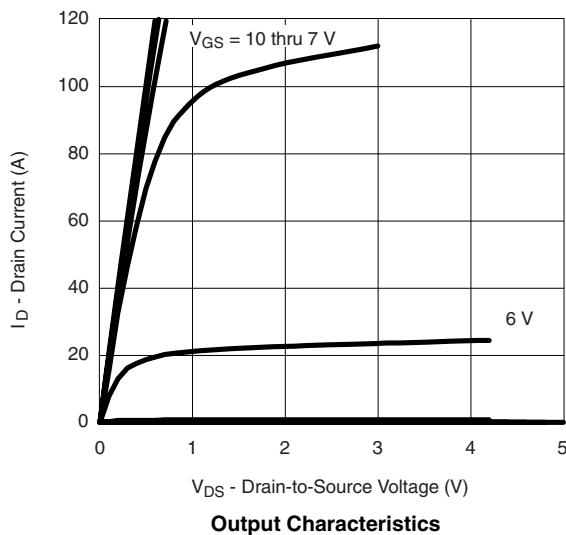
**SPECIFICATIONS**  $T_J = 25^\circ\text{C}$ , unless otherwise noted

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
<b>Static</b>						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{DS}} = 0 \text{ V}, I_D = 250 \mu\text{A}$	60			V
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = 250 \mu\text{A}$	2.5		4.5	
Gate-Body Leakage	$I_{\text{GSS}}$	$V_{\text{DS}} = 0 \text{ V}, V_{\text{GS}} = \pm 20 \text{ V}$			$\pm 250$	nA
Zero Gate Voltage Drain Current	$I_{\text{DSS}}$	$V_{\text{DS}} = 60 \text{ V}, V_{\text{GS}} = 0 \text{ V}$			1	$\mu\text{A}$
		$V_{\text{DS}} = 60 \text{ V}, V_{\text{GS}} = 0 \text{ V}, T_J = 125^\circ\text{C}$			50	
		$V_{\text{DS}} = 60 \text{ V}, V_{\text{GS}} = 0 \text{ V}, T_J = 150^\circ\text{C}$			250	
On-State Drain Current <sup>a</sup>	$I_{\text{D}(\text{on})}$	$V_{\text{DS}} \geq 10 \text{ V}, V_{\text{GS}} = 10 \text{ V}$	70			A
Drain-Source On-State Resistance <sup>a</sup>	$r_{\text{DS}(\text{on})}$	$V_{\text{GS}} = 10 \text{ V}, I_D = 20 \text{ A}$		0.005	0.006	$\Omega$
		$V_{\text{GS}} = 10 \text{ V}, I_D = 20 \text{ A}, T_J = 125^\circ\text{C}$		0.008	0.010	
Forward Transconductance <sup>a</sup>	$g_{\text{fs}}$	$V_{\text{DS}} = 15 \text{ V}, I_D = 20 \text{ A}$		58		S
<b>Dynamic<sup>b</sup></b>						
Input Capacitance	$C_{\text{iss}}$	$V_{\text{GS}} = 0 \text{ V}, V_{\text{DS}} = 30 \text{ V}, f = 1 \text{ MHz}$		4700		pF
Output Capacitance	$C_{\text{oss}}$			620		
Reverse Transfer Capacitance	$C_{\text{rss}}$			250		
Total Gate Charge <sup>c</sup>	$Q_g$	$V_{\text{DS}} = 30 \text{ V}, V_{\text{GS}} = 10 \text{ V}, I_D = 50 \text{ A}$		78.5	120	nC
Gate-Source Charge <sup>c</sup>	$Q_{\text{gs}}$			28		
Gate-Drain Charge <sup>c</sup>	$Q_{\text{gd}}$			20.6		
Gate Resistance	$R_g$	$f = 1 \text{ MHz}$		1.2	2.4	$\Omega$
Turn-On Delay Time <sup>c</sup>	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = 30 \text{ V}, R_L = 0.6 \Omega$ $I_D \geq 50 \text{ A}, V_{\text{GEN}} = 10 \text{ V}, R_g = 1 \Omega$		16	30	ns
Rise Time <sup>c</sup>	$t_r$			10	20	
Turn-Off Delay Time <sup>c</sup>	$t_{\text{d}(\text{off})}$			25	40	
Fall Time <sup>c</sup>	$t_f$			8	15	
<b>Source-Drain Diode Ratings and Characteristics</b> $T_C = 25^\circ\text{C}^b$						
Continuous Current	$I_S$				85	A
Pulsed Current	$I_{\text{SM}}$				240	
Forward Voltage <sup>a</sup>	$V_{\text{SD}}$	$I_F = 20 \text{ A}, V_{\text{GS}} = 0 \text{ V}$		0.83	1.5	V
Reverse Recovery Time	$t_{rr}$	$I_F = 75 \text{ A}, \text{di/dt} = 100 \text{ A}/\mu\text{s}$		62	100	ns
Peak Reverse Recovery Current	$I_{\text{PRM(REC)}}$			3.8	5.7	A
Reverse Recovery Charge	$Q_{rr}$			118	180	nC

Notes:

- a. Pulse test; pulse width  $\leq 300 \mu\text{s}$ , duty cycle  $\leq 2\%$ .
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

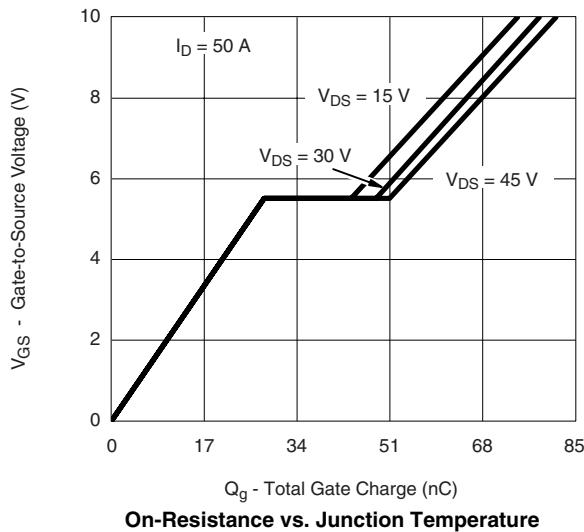
**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted


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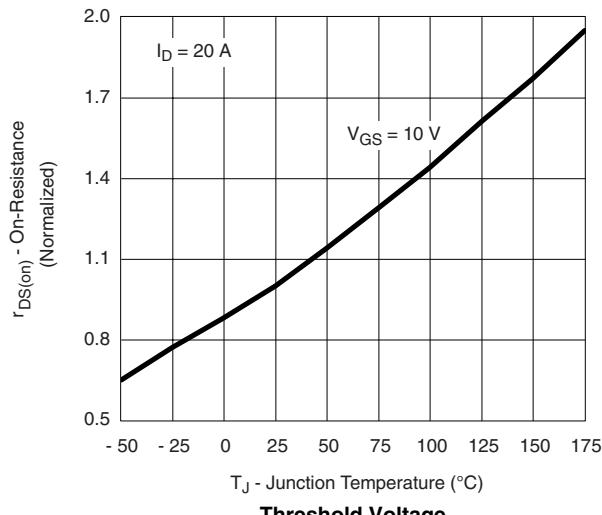
Vishay Siliconix



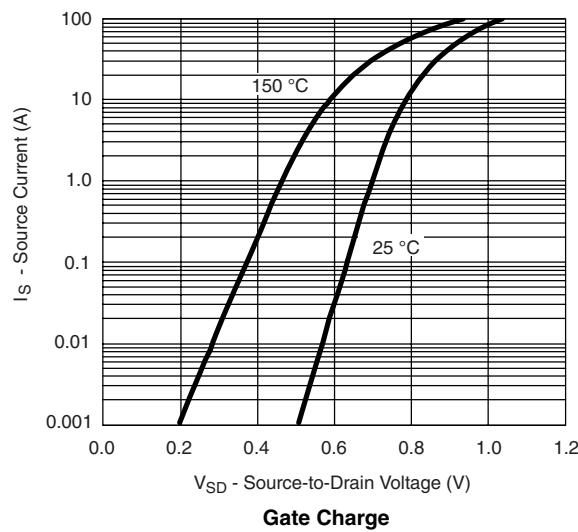
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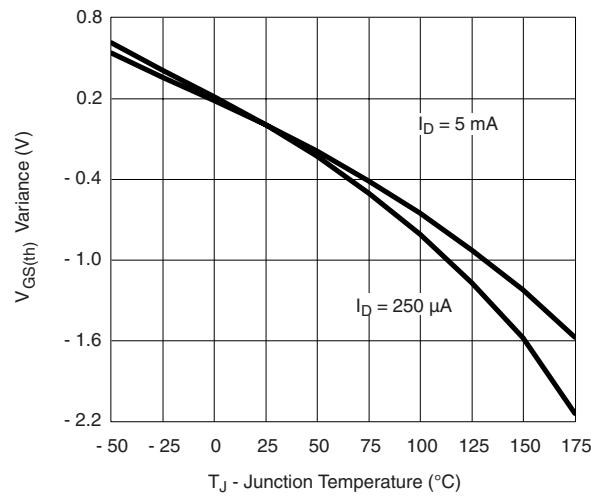
On-Resistance vs. Junction Temperature



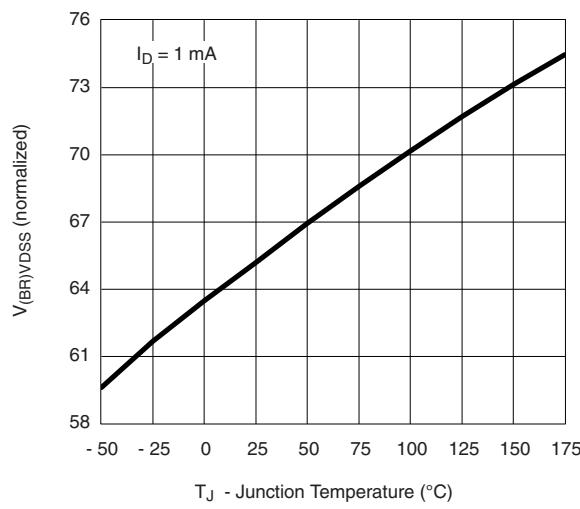
Threshold Voltage



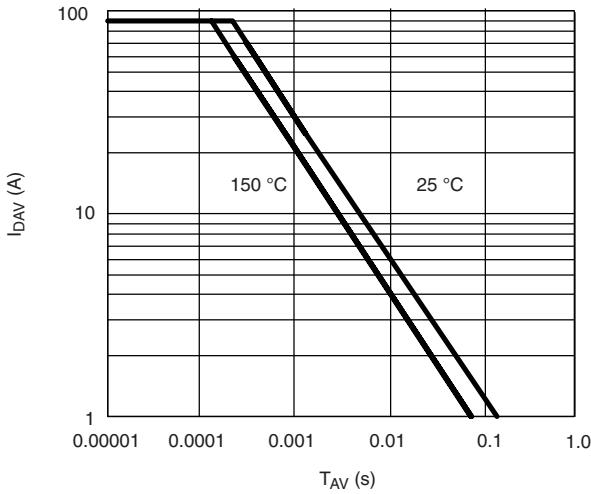
Gate Charge



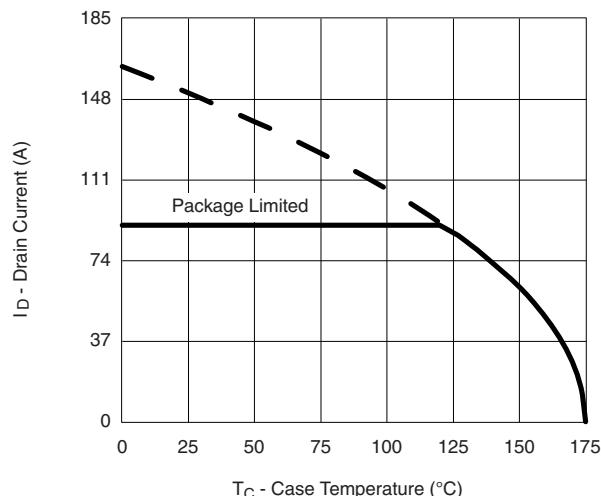
On-Resistance vs. Junction Temperature



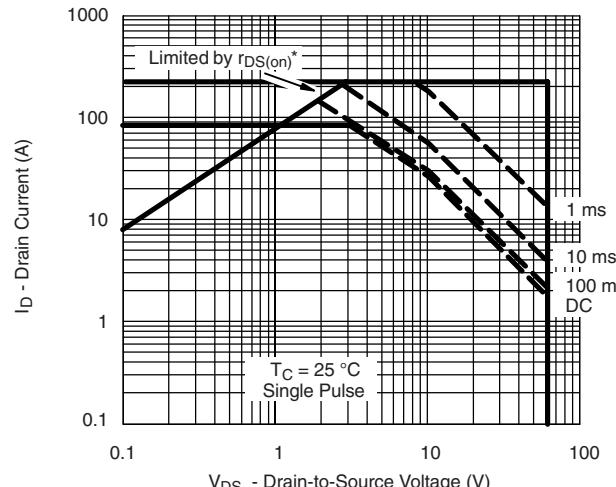
Source-Drain Diode Forward Voltage



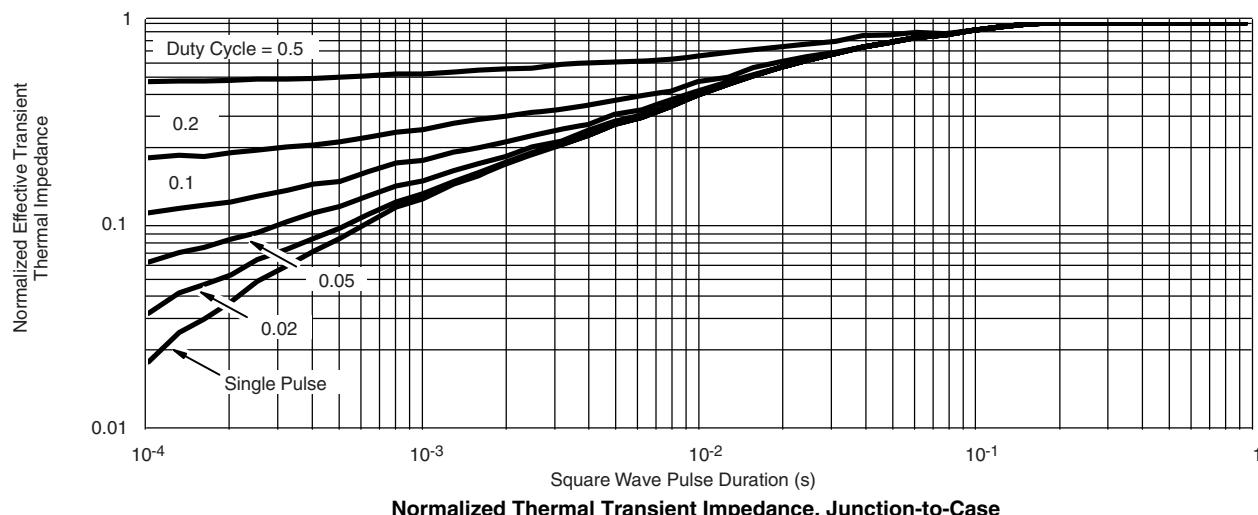
Maximum Drain Current vs. Case Temperature

**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted


Single Pulse Avalanche Current Capability vs. Time


\*  $V_{GS} >$  minimum  $V_{GS}$  at which  $r_{DS(on)}$  is specified

## Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <http://www.vishay.com/ppg?69536>.



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